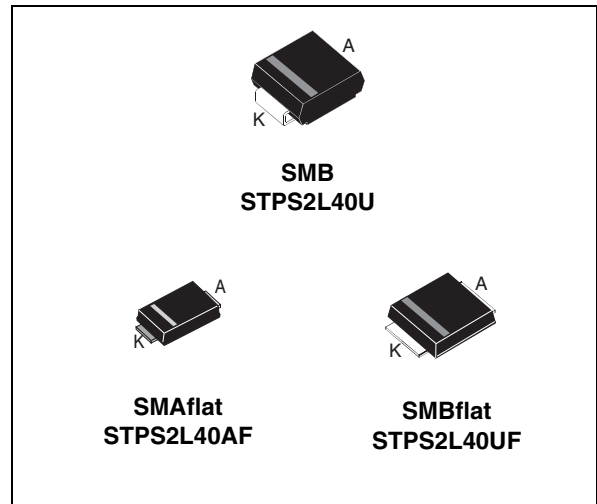


## Features

- Very small conduction losses
- Negligible switching losses
- Low forward voltage drop
- Surface mount miniature package
- Avalanche capability specified
- ECOPACK2<sup>®</sup> halogen-free component (SMAflat and SMBflat)



**Table 1. Device summary**

$I_{F(AV)}$	2 A
$V_{RRM}$	40 V
$T_j$ (max)	150 °C
$V_F$ (max)	0.34 V

# 1 Characteristics

**Table 2. Absolute ratings (limiting values)**

Symbol	Parameter		Value	Unit	
$V_{RRM}$	Repetitive peak reverse voltage		40	V	
$I_{F(AV)}$	Average forward current	SMB	$T_L = 130\text{ °C } \delta = 0.5$	2	A
		SMBflat	$T_L = 140\text{ °C } \delta = 0.5$		
		SMAflat	$T_L = 130\text{ °C } \delta = 0.5$		
$I_{FSM}$	Surge non repetitive forward current	$t_p = 10\text{ ms}$ sinusoidal	75	A	
$P_{ARM}$	Repetitive peak avalanche power	$t_p = 1\text{ }\mu\text{s } T_j = 25\text{ °C}$	2200	W	
$T_{stg}$	Storage temperature range		-65 to + 150	°C	
$T_j$	Operating junction temperature <sup>(1)</sup>		150	°C	

1.  $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$  condition to avoid thermal runaway for a diode on its own heatsink

**Table 3. Thermal resistances**

Symbol	Parameter		Value	Unit
$R_{th(j-l)}$	Junction to lead	SMB	20	°C/W
		SMBflat	10	
		SMAflat	20	

**Table 4. Static electrical characteristics**

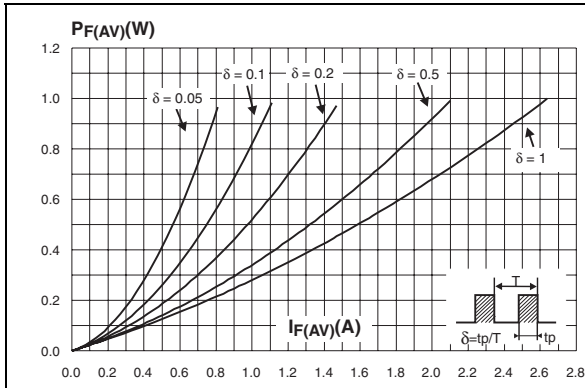
Symbol	Tests conditions		Min.	Typ.	Max.	Unit
$I_R^{(1)}$	Reverse leakage current	$T_j = 25\text{ °C}$	$V_R = 40\text{ V}$		220	$\mu\text{A}$
		$T_j = 100\text{ °C}$			20	mA
		$T_j = 125\text{ °C}$		38	80	mA
$V_F^{(1)}$	Forward voltage drop	$T_j = 25\text{ °C}$	$I_F = 1\text{ A}$		0.39	V
		$T_j = 125\text{ °C}$		0.25	0.28	
		$T_j = 25\text{ °C}$	$I_F = 2\text{ A}$		0.43	V
		$T_j = 125\text{ °C}$		0.31	0.34	
		$T_j = 25\text{ °C}$	$I_F = 4\text{ A}$		0.5	V
		$T_j = 125\text{ °C}$		0.39	0.45	

1. Pulse test:  $t_p = 380\text{ }\mu\text{s}$ ,  $\delta < 2$

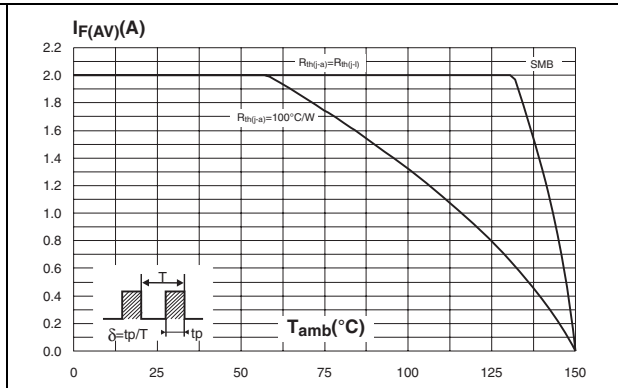
To evaluate the conduction losses use the following equation:

$$P = 0.22 \times I_{F(AV)} + 0.06 I_{F(RMS)}^2$$

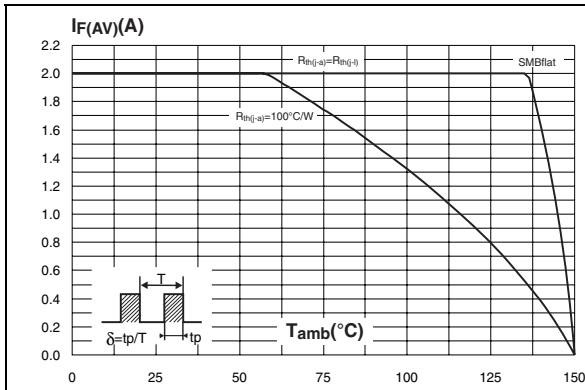
**Figure 1. Average forward power dissipation versus average forward current**



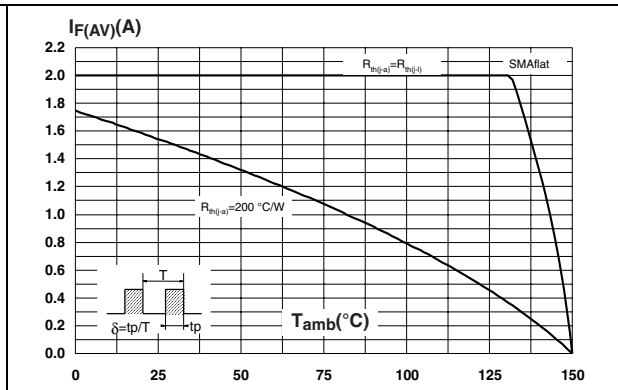
**Figure 2. Average forward current versus ambient temperature (delta = 0.5) SMB**



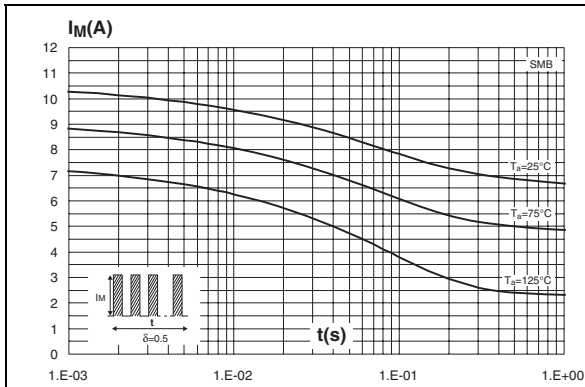
**Figure 3. Average forward current versus ambient temperature (delta = 0.5) SMBflat**



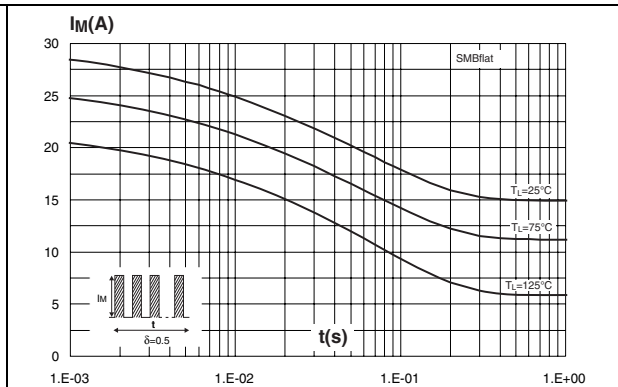
**Figure 4. Average forward current versus ambient temperature (delta = 0.5) SMAflat**



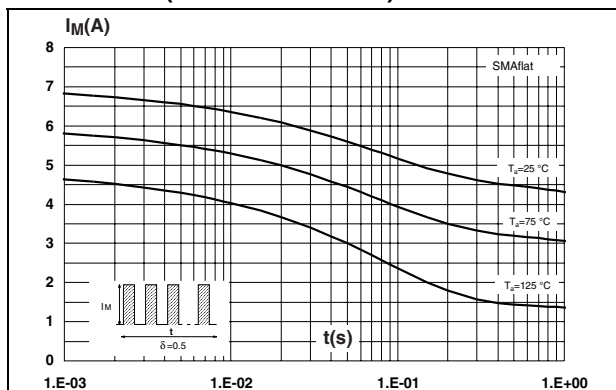
**Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values) SMB**



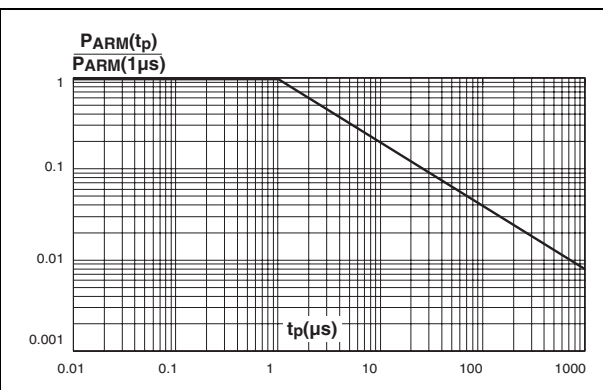
**Figure 6. Non repetitive surge peak forward current versus overload duration (maximum values) SMBflat**



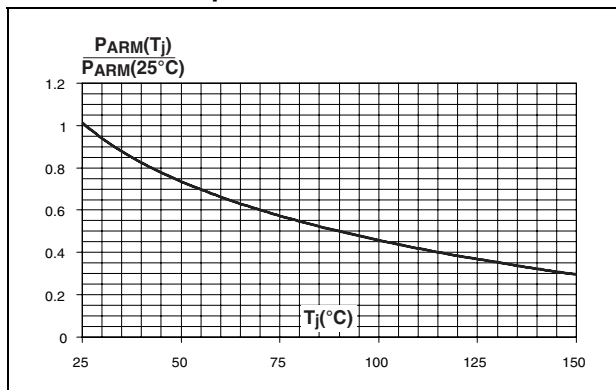
**Figure 7. Non repetitive surge peak forward current versus overload duration (maximum values) SMAflat**



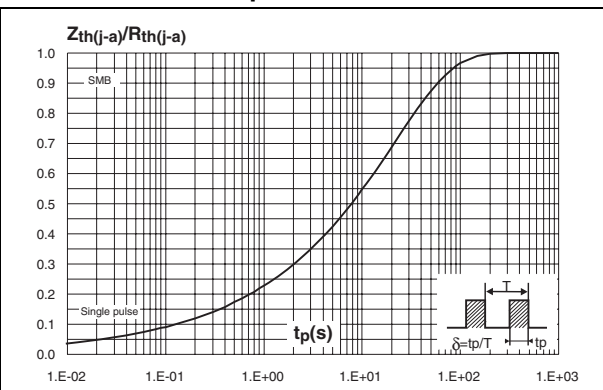
**Figure 8. Normalized avalanche power derating versus pulse duration**



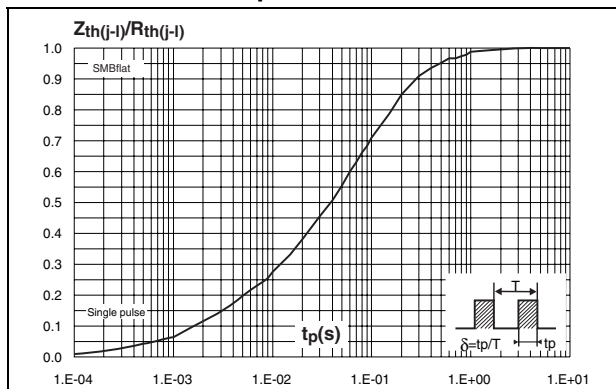
**Figure 9. Normalized avalanche power derating versus junction temperature**



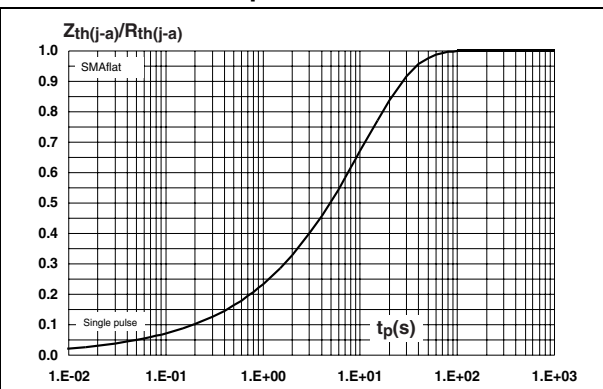
**Figure 10. Relative variation of thermal impedance junction to ambient versus pulse duration - SMB**



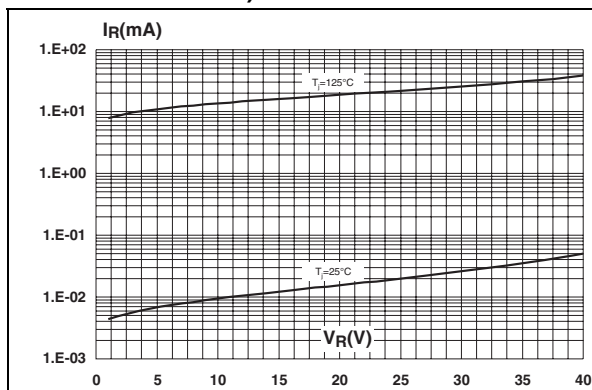
**Figure 11. Relative variation of thermal impedance junction to lead versus pulse duration - SMBflat**



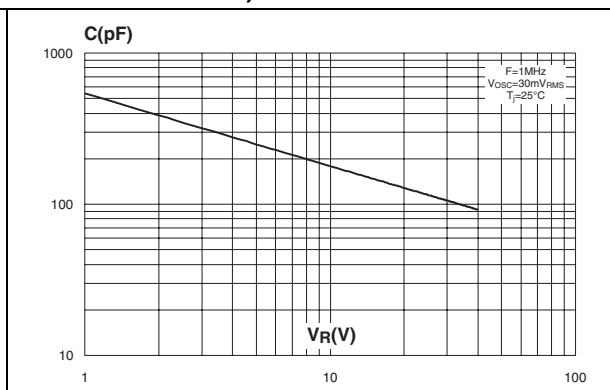
**Figure 12. Relative variation of thermal impedance junction to ambient versus pulse duration - SMAflat**



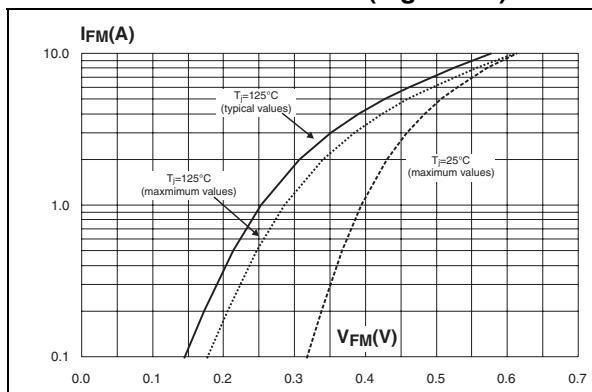
**Figure 13. Reverse leakage current versus reverse voltage applied (typical values)**



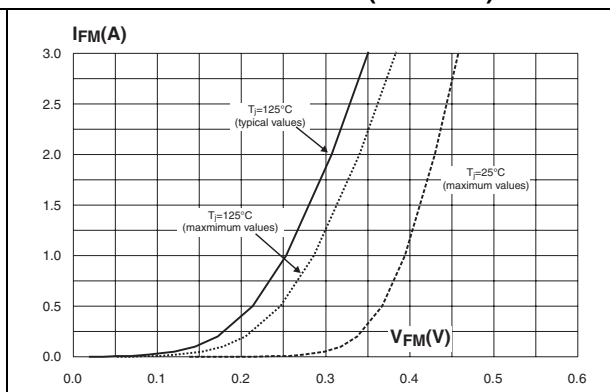
**Figure 14. Junction capacitance versus reverse voltage applied (typical values)**



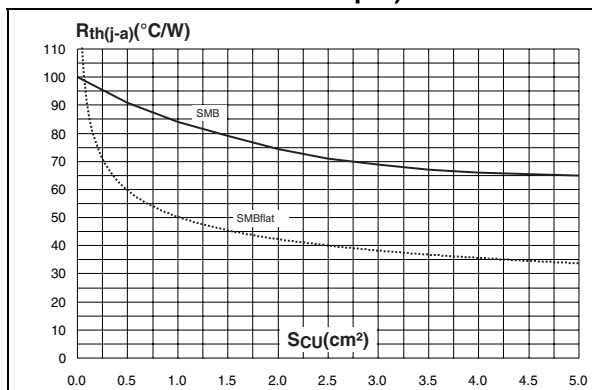
**Figure 15. Forward voltage drop versus forward current (high level)**



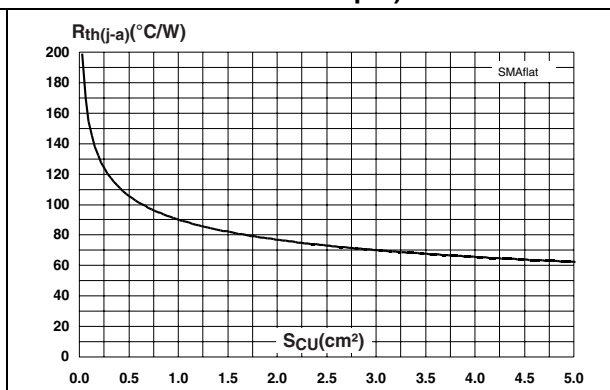
**Figure 16. Forward voltage drop versus forward current (low level)**



**Figure 17. Thermal resistance junction to ambient versus copper surface under each lead, SMB, SMBflat (epoxy printed board FR4, copper thickness = 35  $\mu\text{m}$ )**



**Figure 18. Thermal resistance junction to ambient versus copper surface under each lead, SMAflat (epoxy printed board FR4, copper thickness = 35  $\mu\text{m}$ )**



## 2 Package Information

Table 5. SMB dimensions

Ref.	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A1	1.90	2.45	0.075	0.096
A2	0.05	0.20	0.002	0.008
b	1.95	2.20	0.077	0.087
c	0.15	0.40	0.006	0.016
E	5.10	5.60	0.201	0.220
E1	4.05	4.60	0.159	0.181
D	3.30	3.95	0.130	0.156
L	0.75	1.50	0.030	0.059

Figure 19. SMB footprint dimensions in millimeters (inches)

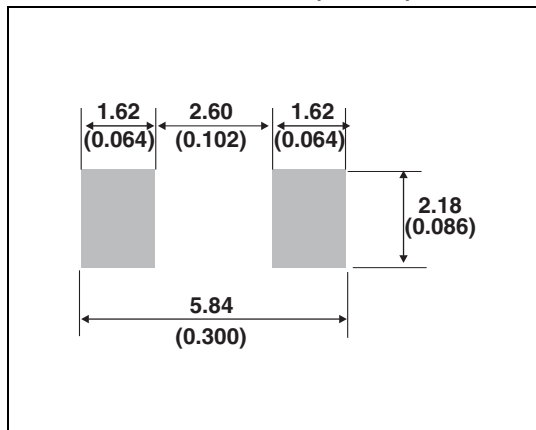
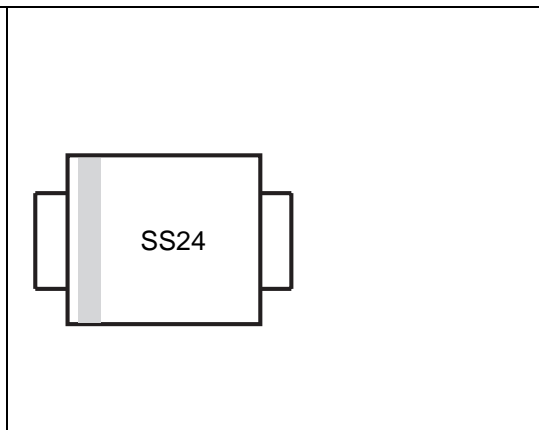


Figure 20. Marking information

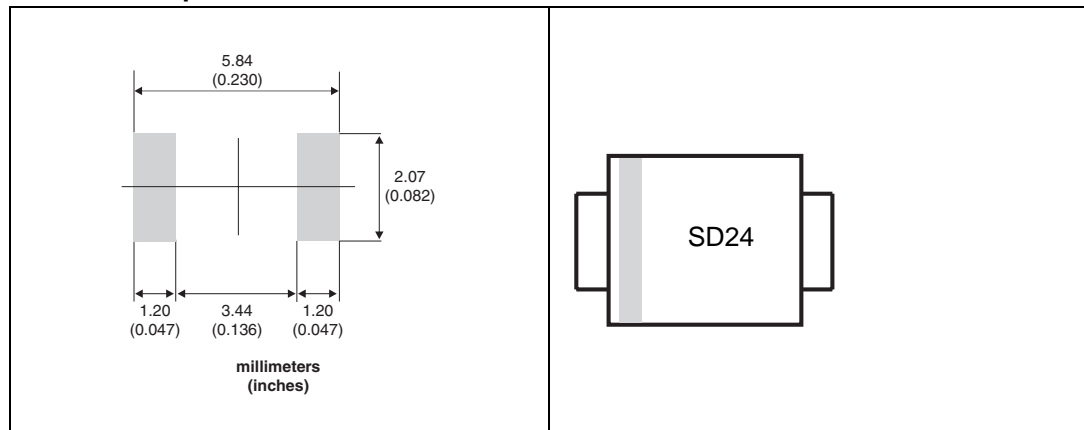


**Table 6. SMBflat dimensions**

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90		1.10	0.035		0.043
b <sup>(1)</sup>	1.95		2.20	0.077		0.087
c <sup>(1)</sup>	0.15		0.40	0.006		0.016
D	3.30		3.95	0.130		0.156
E	5.10		5.60	0.200		0.220
E1	4.05		4.60	0.189		0.181
L	0.75		1.50	0.029		0.059
L1		0.40			0.016	
L2		0.60			0.024	

1. Applies to plated leads

**Figure 21. SMBflat footprint dimensions** **Figure 22. Marking information optimized for SMBflat<sup>(1)</sup>**

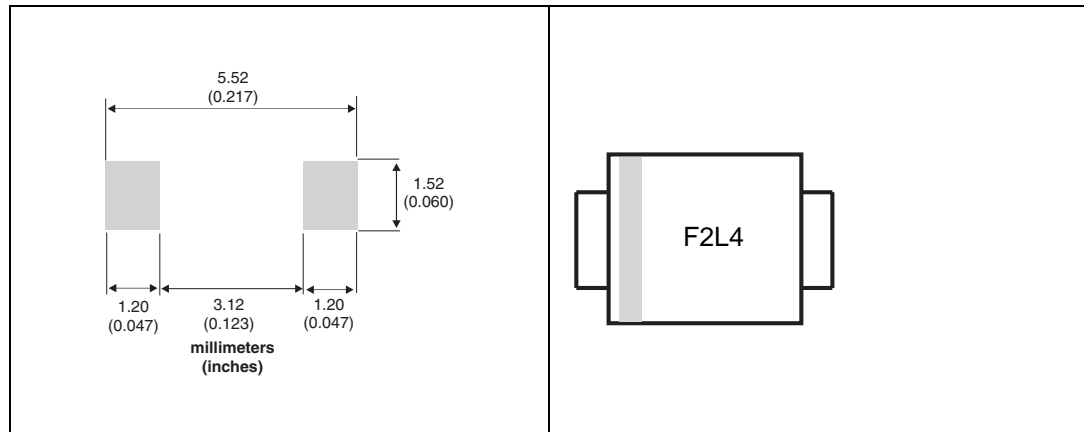


1. SMB footprint may also be used.

**Table 7. SMAflat dimensions**

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90		1.10	0.035		0.043
b	1.25		1.65	0.049		0.065
c	0.15		0.40	0.006		0.016
D	2.25		2.95	0.088		0.116
E	4.80		5.60	0.189		0.220
E1	3.95		4.60	0.156		0.181
L	0.75		1.50	0.030		0.059
L1		0.50			0.019	
L2		0.50			0.019	

**Figure 23. SMAflat footprint dimensions** **Figure 24. Marking information optimized for SMAflat<sup>(1)</sup>**



1. SMA footprint may also be used.



### 3 Ordering Information

**Table 8. Ordering information**

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS2L40U	SS24	SMB	0.107 g	3000	Tape and reel
STPS2L40UF	SD24	SMBflat	0.50 g	3000	Tape and reel
STPS2L40AF	F2L4	SMAflat	0.35 g	2000	Tape and reel

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